

Electronic Patent Application Fee Transmittal

Application Number:	10046739
Filing Date:	17-Jan-2002
Title of Invention:	THIN-FILM CRYSTAL WAFER HAVING PN JUNCTION AND METHOD FOR FABRICATING THE WAFER
First Named Inventor/Applicant Name:	Hisashi Yamada
Filer:	Andrew Duff Meikle/Linda Ruff
Attorney Docket Number:	3885-0102P

Filed as Large Entity

Utility under 35 USC 111(a) Filing Fees

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
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Basic Filing:

Pages:

Claims:

Miscellaneous-Filing:

Petition:

Application for patent term adjustment	1455	1	200	200
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Patent-Appeals-and-Interference:

Post-Allowance-and-Post-Issuance:

Extension-of-Time:

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				200